

Polyphenylene sulfide

Fortron[®] FX72T6 is an unreinforced, impact modified PPS with high flowability and high impact resistance suitable for injection molding.

The mechanical properties reported on this data sheet refer to a mold wall temperature of 135°C.

Product information

| Resin IdentificationPPSPart Marking Code>PPS | |
|--|--|
| Rheological properties | |
| Melt mass-flow rate, Temperature310Melt mass-flow rate, Load2.16 | i g/10min ISO 1133 °C i kg i % ISO 294-4, 2577 |
| | % ISO 234-4, 2377 % ISO 294-4, 2577 |
| Typical mechanical properties | |
| Tensile modulus1680Tensile stress at break, 50mm/min40Tensile strain at break, 50mm/min20Flexural modulus1700Charpy impact strength, 23°CNCharpy notched impact strength, 23°C10Izod notched impact strength, 23°C10 | MPa ISO 527-1/-2 MPa ISO 527-1/-2 % ISO 527-1/-2 MPa ISO 527-1/-2 MPa ISO 527-1/-2 MPa ISO 178 kJ/m² ISO 179/1eU kJ/m² ISO 179/1eA kJ/m² ISO 180/1A kJ/m² ISO 180/1U |
| Thermal properties | |
| | °C ISO 75-1/-2 °C ISO 306 |
| Flammability | |
| 5 | class IEC 60695-11-10 mm IEC 60695-11-10 % ISO 4589-1/-2 |
| Electrical properties | |
| Relative permittivity, 1MHz3.1Dissipation factor, 1MHz3 | IEC 62631-2-1 IEC 62631-2-1 |
| Physical/Other properties | |
| Density 1180 | kg/m ³ ISO 1183 |



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Injection

| Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer | yes 130 °C 2 - 4 h |
|---|----------------------------|
| Processing Moisture Content | ≤0.02 % |
| Melt Temperature Optimum | 330 °C |
| Min. melt temperature | 310 °C |
| Max. melt temperature | 340 °C |
| Screw tangential speed | 0.2 - 0.3 m/s |
| Mold Temperature Optimum | 150 °C |
| Min. mould temperature | 140 °C |
| Max. mould temperature | 160 °C |
| Hold pressure range | 30 - 70 MPa |
| Back pressure | 3.5 MPa |
| Ejection temperature | 225 °C |

Additional information

Injection molding

Processing

Injection Molding:

Drying - alternate 80°C, approx. 6 hours

Mold surface temperature – a wide range of 30° C to 135° C is possible. Highest crystallinity will often be achieved at higher mold temperature. Depending on the part design, improved surface appearance and demolding may be achieved at 50° C to 70° C.

Processing Notes

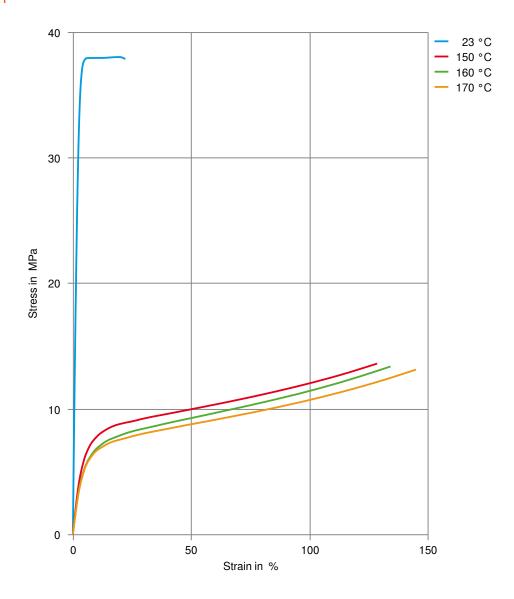
Pre-Drying

Fortron® should in principle be predried. Because of the necessary low maximum residual moisture content, the use of dry air dryers is recommended. The dew point should be < -30 °C. The time between drying and processing should be as short as possible.



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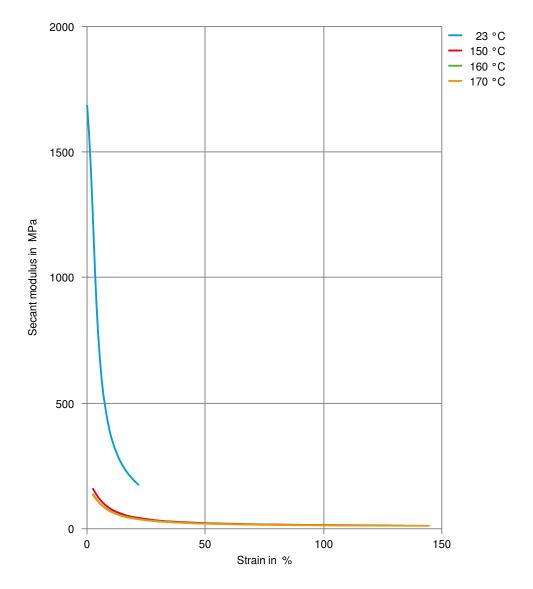
Stress-strain





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Secant modulus-strain



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Page: 4 of 4

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